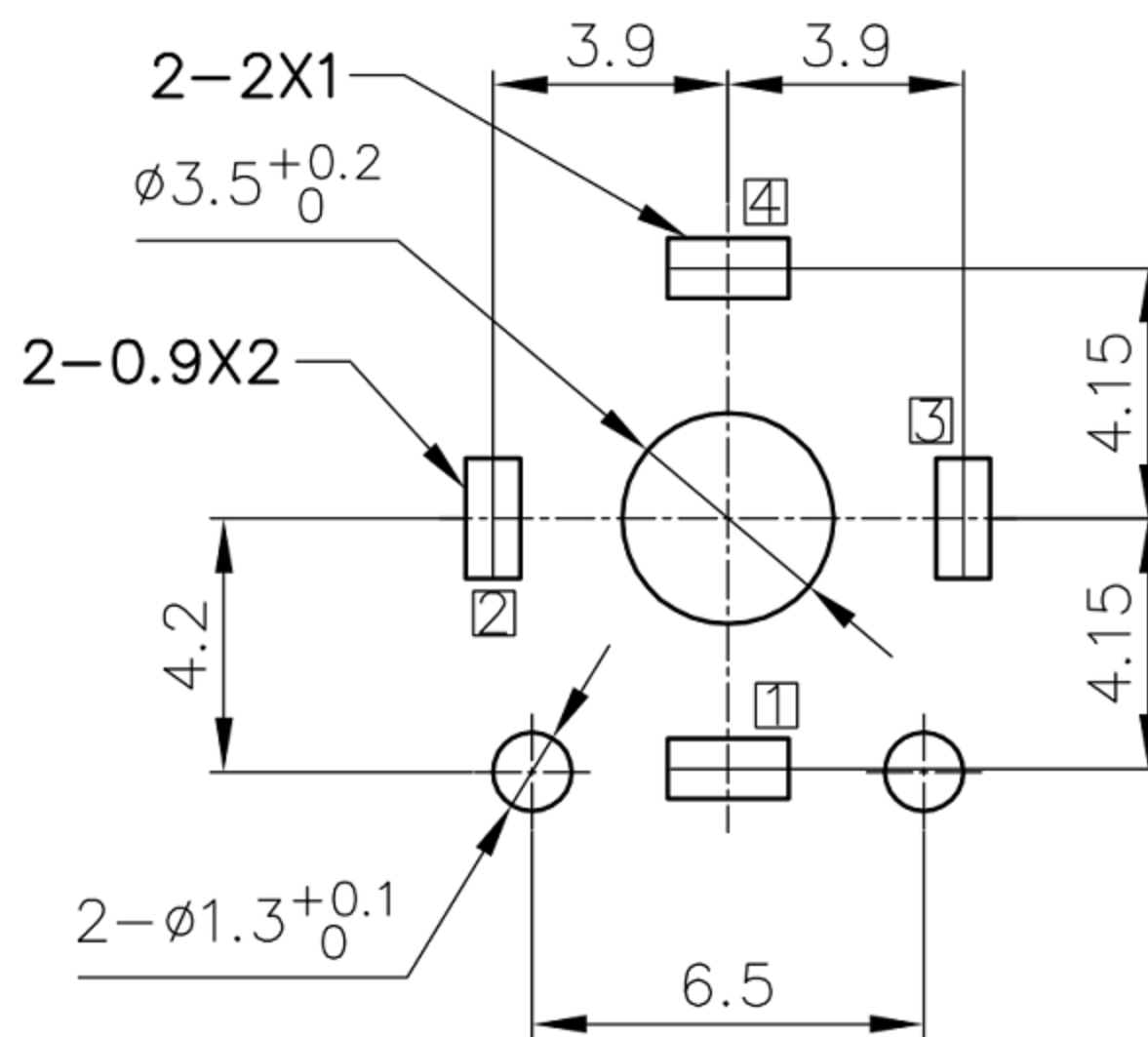
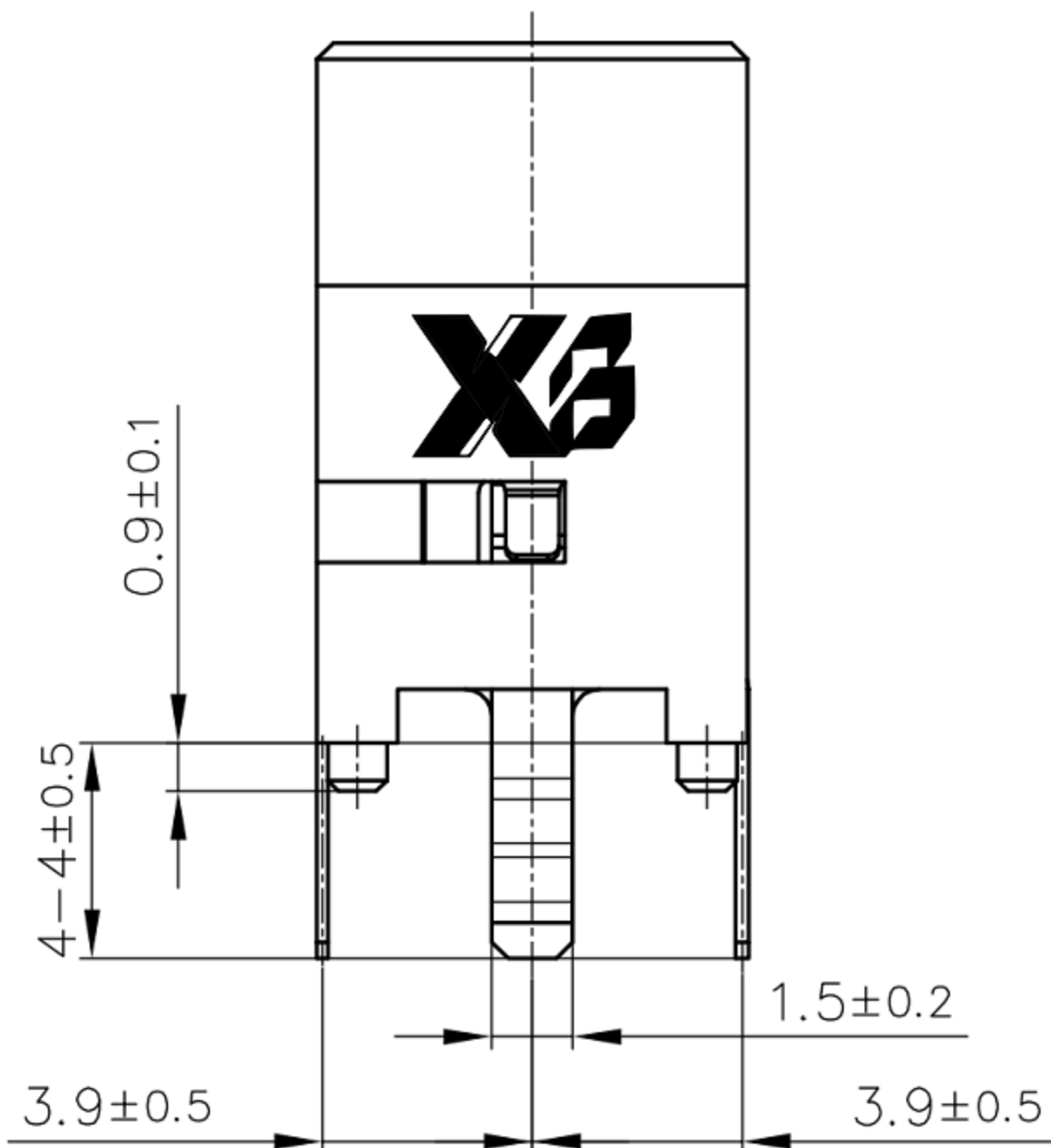
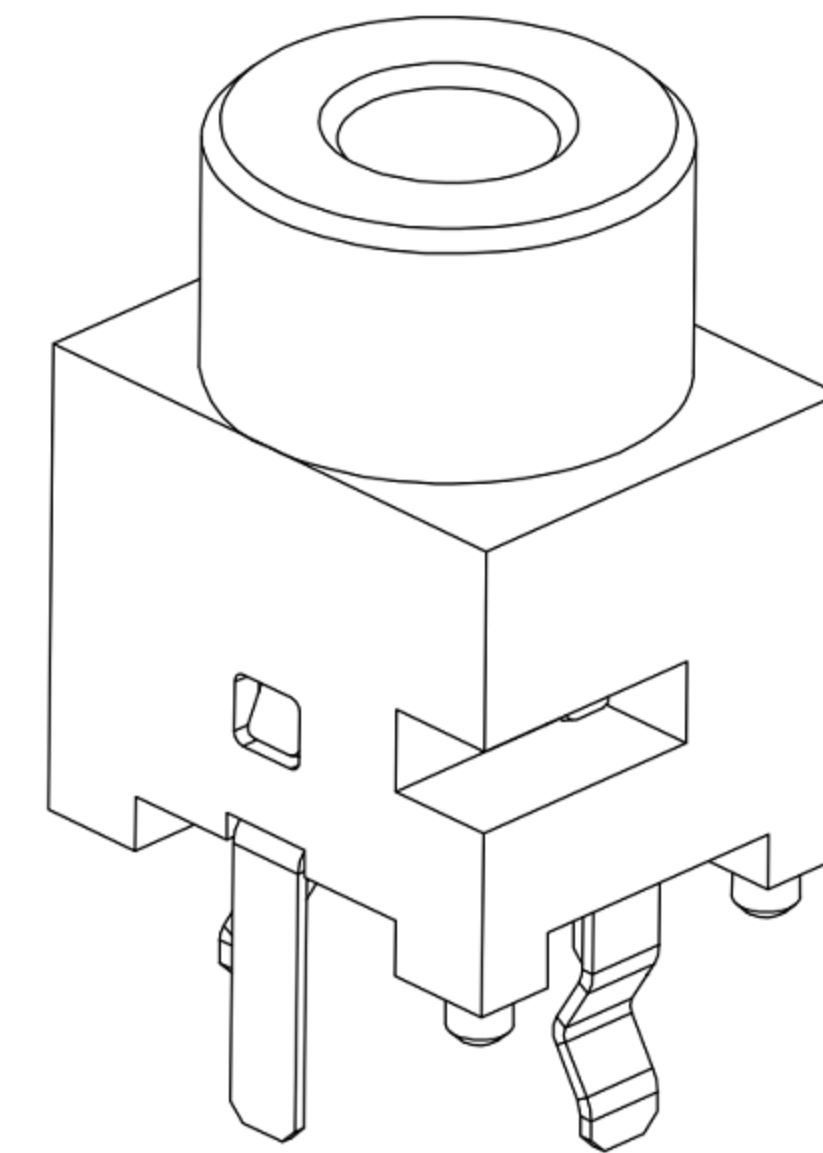
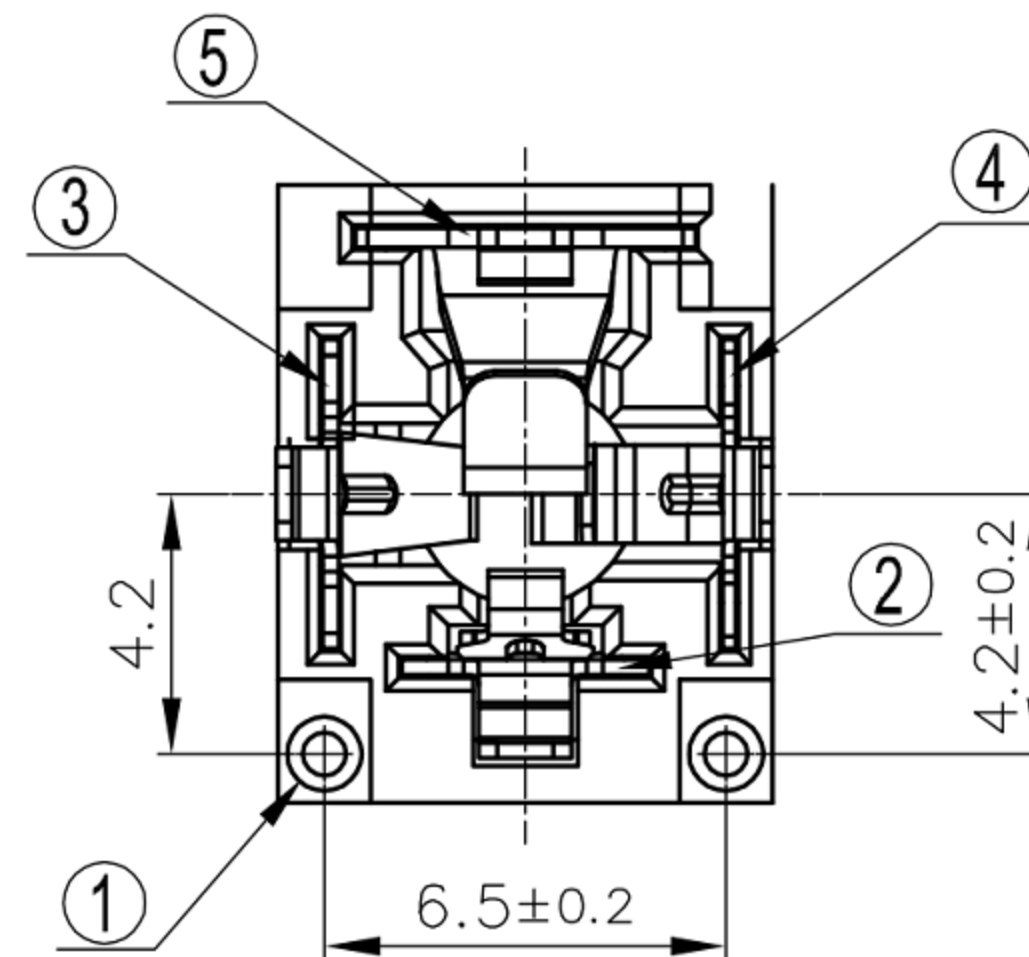
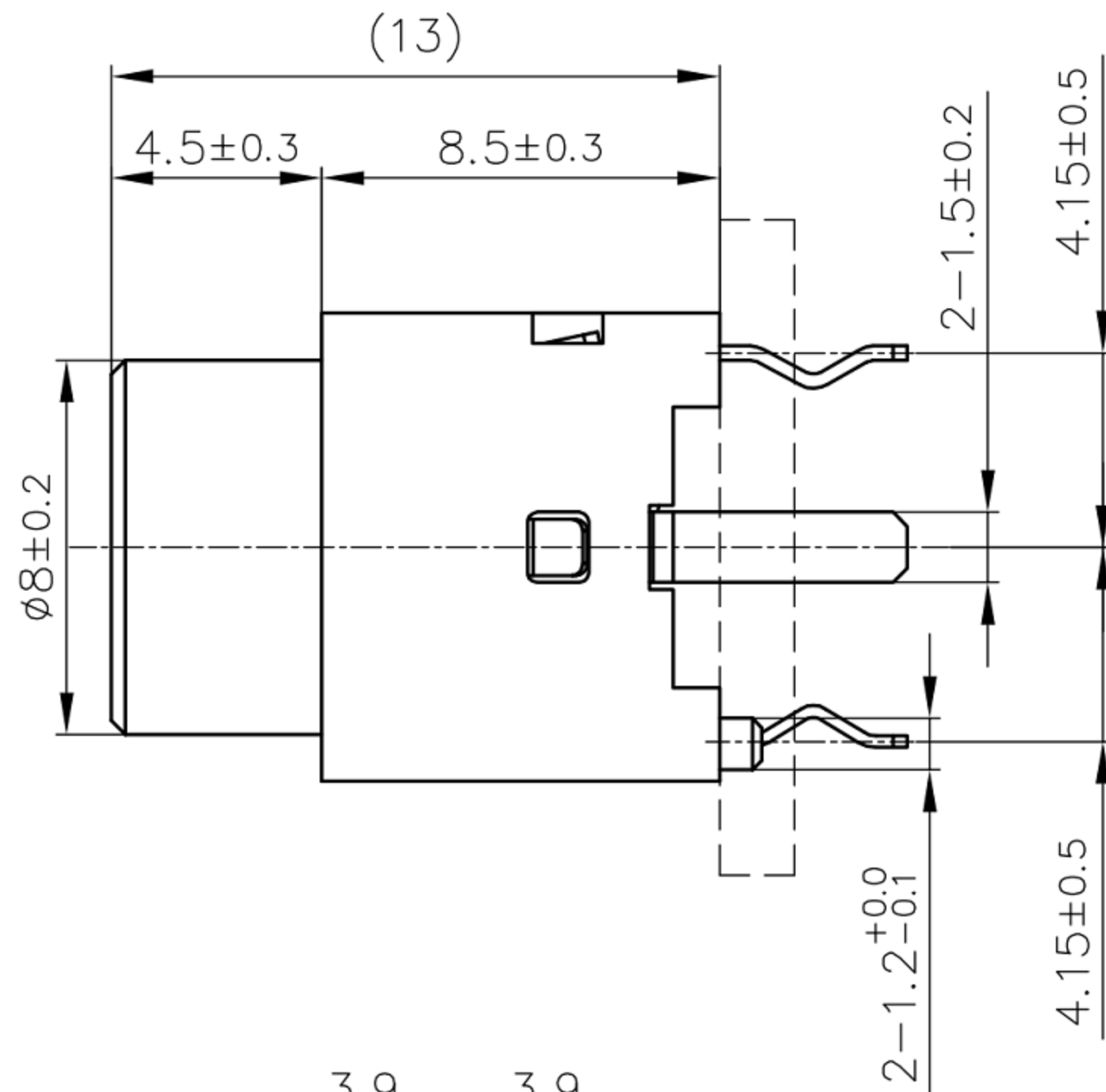
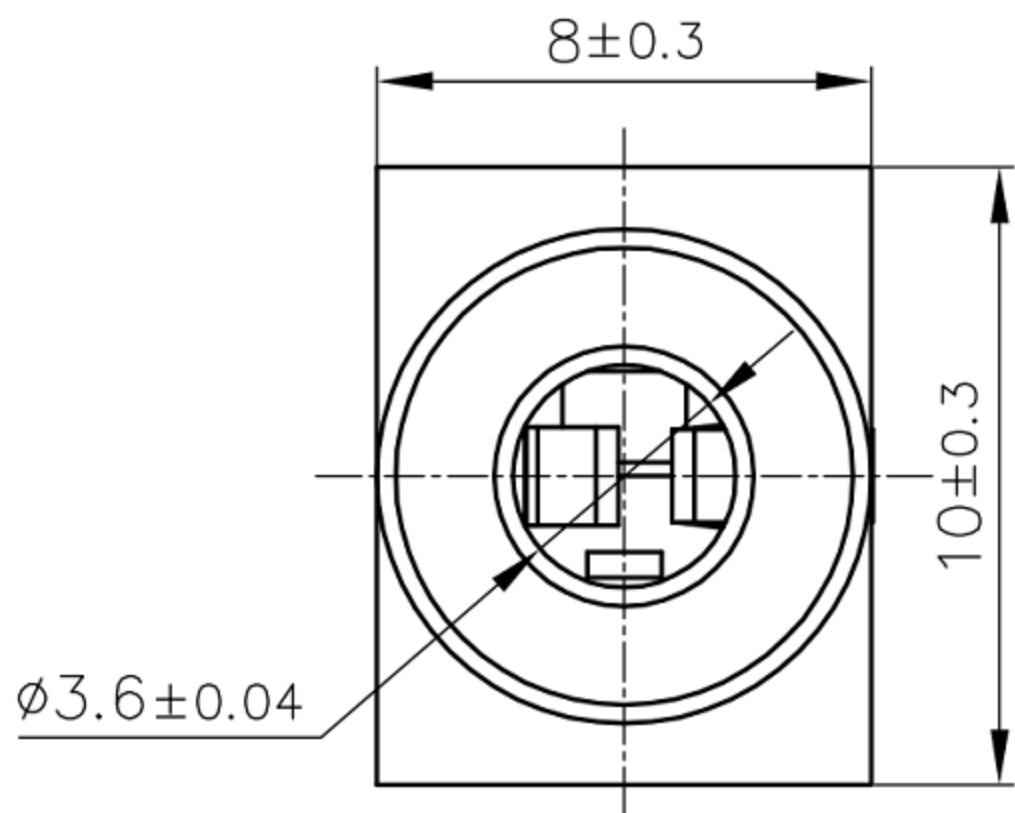




CAD FILE:

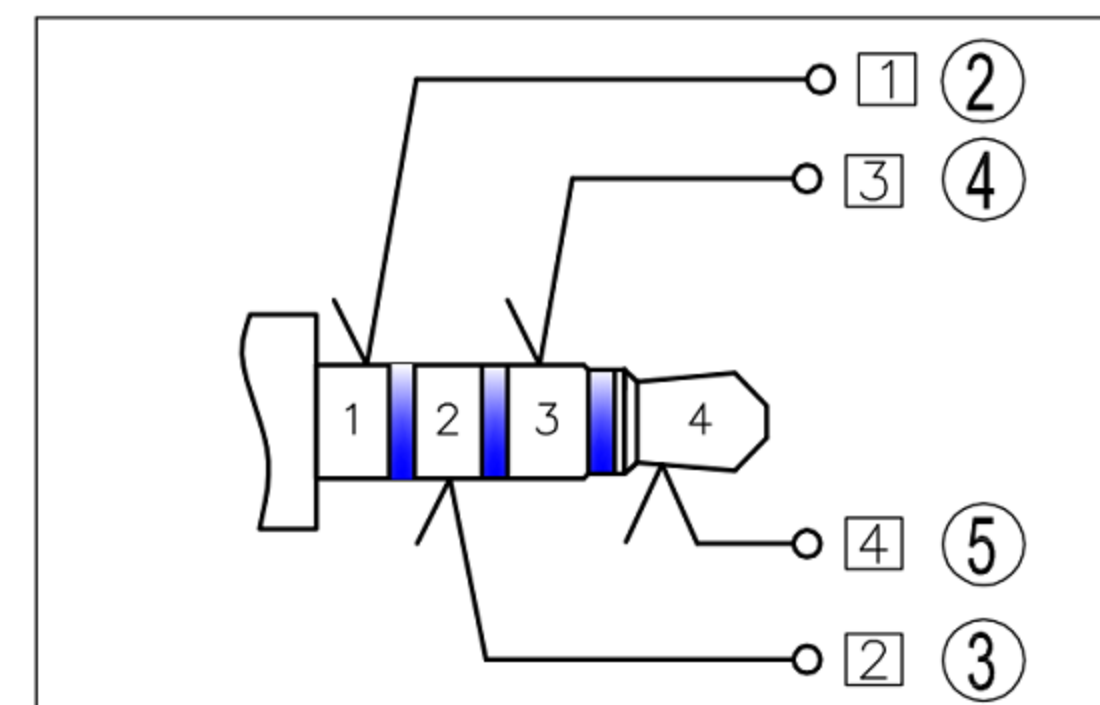
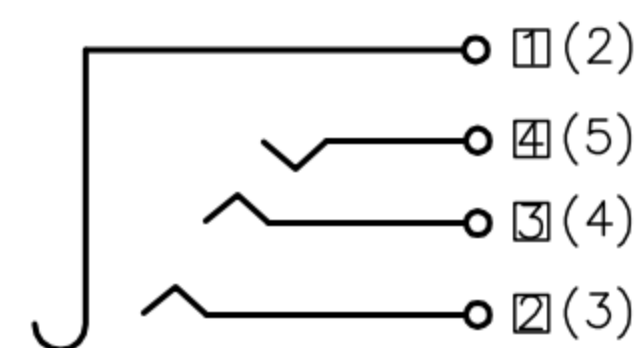


印制线路板示意图(底视图)

[Tolerance/公差±0.05]

P.C.B. Layout(Bottom View)

电路原理图
Schematic



⑤	接触片4# Tip Spring	1	PHOSPHOR BRONZE	镀Ni 30u" Ag 0.2um
④	接触片3# Ring Spring	1	PHOSPHOR BRONZE	镀Ni 30u" Ag 0.2um
③	接触片2# Sleeve Spring2	1	PHOSPHOR BRONZE	镀Ni 30u" Ag 0.2um
②	接触片1# Sleeve Spring1	1	PHOSPHOR BRONZE	镀Ni 30u" Ag 0.2um
①	基座 Housing	1	PBT +GF15% 94V-0	黑色 Black
序号 NO.	零件名称 Part Name	数量 Q'ty	材料及规格 Material	电镀/备注 Plating/Remark

8					TOLERANCE				
7					UNLESS SPECIFIED				
6					WITHIN 1.5mm : ±0.1mm	A	2012-9-25	初 版	ZENQ. CHEN
5					OVER 1.5mm : ±0.2mm	ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : Audio Jack			UNIT : mm	DRWG NO.: XB-PJ-377-4P-L
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: XB-PJ-377-4P-L			SCALE: 5:1	DWN. JUN. YANG 2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司			CHK'D	DONG. PANG 2012-9-25
1	KNOB	PPA	1	BLACK				APPD.	ZENQ. CHEN 2012-9-25
NO.	PARTS	MATERIALS	Q'TY	FINISH	DONG GUAN XI BANG ELECTRONI CS CO., LTD.				